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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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P-Channel Power Trench[®] MOSFET -80 V, -2.1 A, 183 m Ω

Features

- Max r_{DS(on)} = 183 mΩ at V_{GS} = -10 V, I_D = -2.1 A
- Max r_{DS(on)} = 233 mΩ at V_{GS} = -4.5 V, I_D = -1.9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

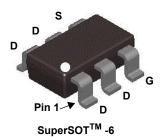


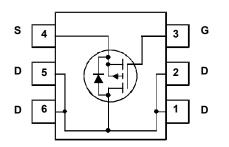
General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage	-80	V		
V _{GS}	Gate to Source Voltage		±20	V	
ID	Drain Current -Continuous	(Note 1a)	-2.1		
	-Pulsed		-10	— A	
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	37	mJ	
P _D	Power Dissipation	(Note 1a)	1.6	w	
	Power Dissipation	(Note 1b)	0.7	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case		30	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Not	te 1a)	78	C/VV

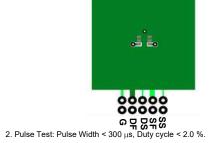
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.535	FDC3535	SSOT-6	7 "	8 mm	3000 units

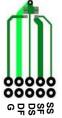
April 2015

FDC3535
P-Channel
Power T
rench [®] I
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-80			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		-64		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -64 V, V _{GS} = 0 V			-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		5		mV/°C
0		V _{GS} = -10 V, I _D = -2.1 A		147	183	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.9 \text{ A}$		176	233	
		V_{GS} = -10 V, I_D = -2.1 A, T_J = 125 °C		246	307	
9 _{FS}	Forward Transconductance	V _{DD} = -10 V, I _D = -2.1 A		6.3		S
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	─ V _{DS} = -40 V, V _{GS} = 0 V, f = 1 MHz		49 24 5.7	65 40	pF pF Ω
	g Characteristics			0.5	10	1
t _{d(on)}	Turn-On Delay Time			6.5	13	ns
t _r	Rise Time	V_{DD} = -40 V, I _D = -2.1 A, V _{GS} = -10 V, R _{GEN} = 6 Ω		3.1	10	ns
t _{d(off)}	Turn-Off Delay Time Fall Time	=		23 2.9	38 10	ns
t _f	Total Gate Charge	V _{GS} = 0 V to -10 V		14	20	ns nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } -4.5 V V_{DD} = -40 V$		6.8	10	nC
Q _{gs}	Total Gate Charge	$I_{D} = -2.1 \text{ A}$		1.6	10	nC
Q _{gd}	Gate to Drain "Miller" Charge			2.7		nC
	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.1 A (Note 2)		-0.81	-1.3	V
t _{rr}	Reverse Recovery Time			25	40	ns
Q _{rr}	Reverse Recovery Charge	I _F = -2.1 A, di/dt = 100 A/μs		23	38	nC
Qrr				-		1

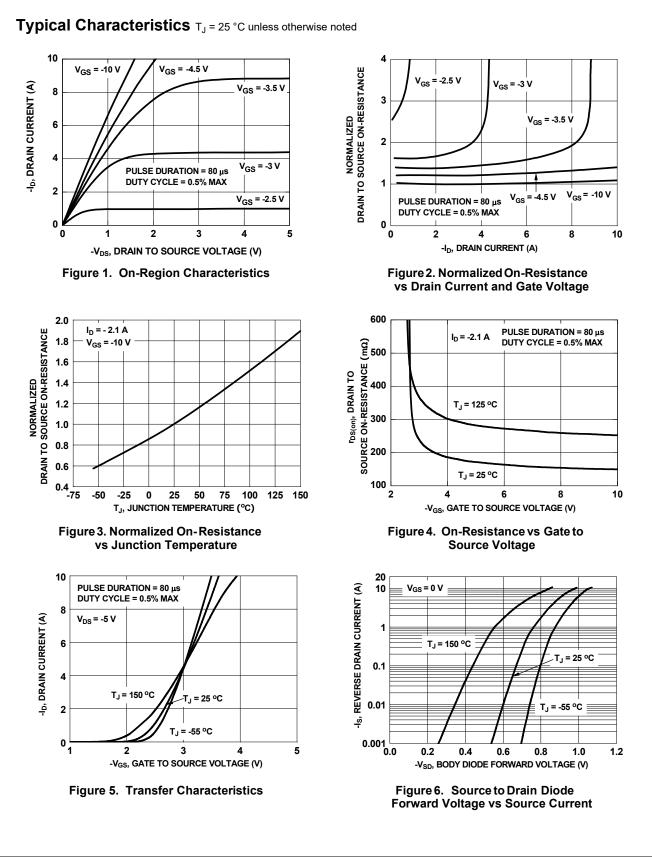


3. Starting T_J = 25 o C, L = 3 mH, I_{AS} = -5 A, V_{DD} = -80 V, V_{GS} = -10 V.



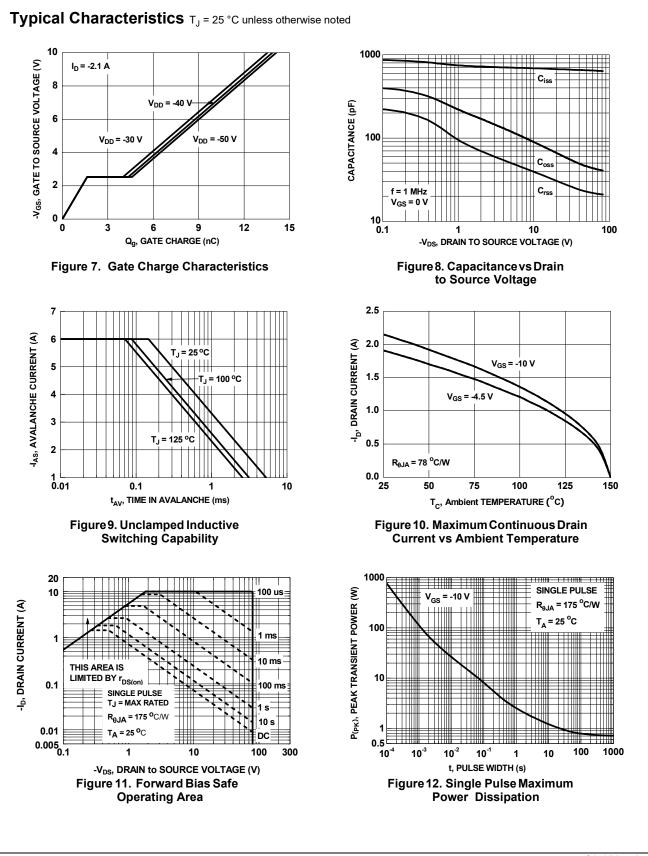


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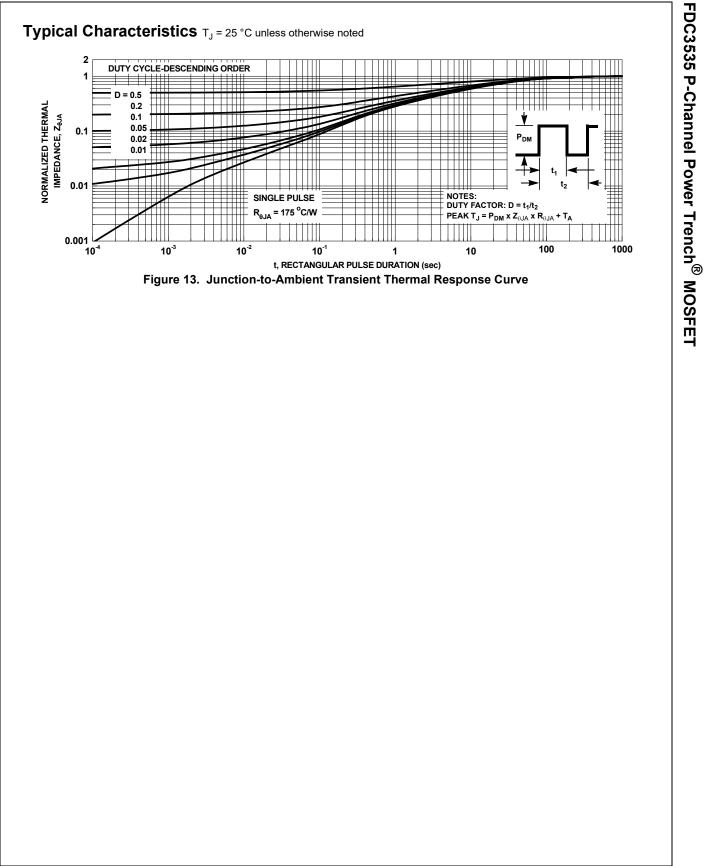


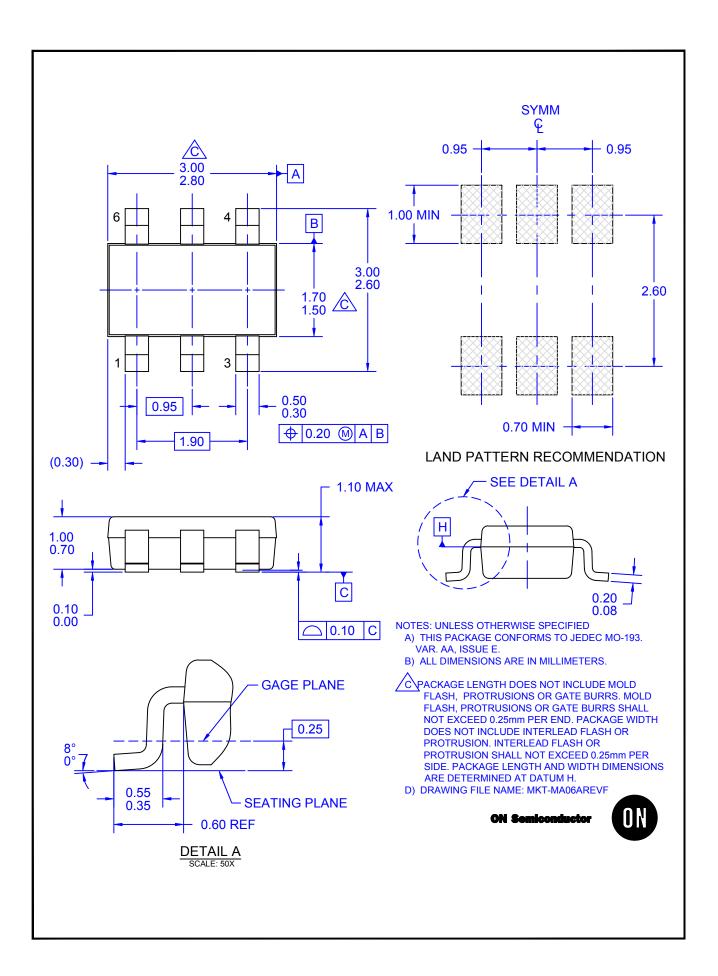
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FDC3535 P-Channel Power Trench[®] MOSFET





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